

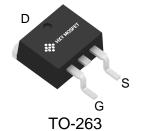
General Description

The IRF100S201 use advanced SGT MOSFET

technology to provide low RDS(ON), low gate charge,

fast switching and excellent avalanche characteristics.

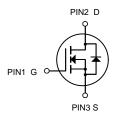
This device is specially designed to get better ruggedness and suitable.



General Features

V_{DS} =100V I_D =260A

 $R_{DS(ON)}$ < 4.2m Ω @ V_{GS} =10V



N-Channel MOSFET

Applications

Consumer electronic power supply Motor control

Synchronous-rectification Isolated DC

Synchronous-rectification applications

Package Marking and Ordering Information

Product ID	Pack	Brand	Qty(PCS)
IRF100S201	TO-263	HXY MOSFET	800

Absolute Maximum Ratings at T_j=25°C unless otherwise noted

Parameter		Symbol	Value	Unit	
Drain-Source Voltage		V _{DS}	100	V	
Gate-Source Voltage		V _{GS}	±20	V	
	T _C =25°C		260	А	
Continuous Drain Current	T _C =100°C	lο	163		
Pulsed Drain Current ¹		I _{DM}	1028	А	
Single Pulse Avalanche Energy ²		EAS	583	mJ	
Total Power Dissipation	T _C =25°C	P _D	379	W	
Operating Junction and Storage Temperature Range		T _J , T _{STG}	-55 to 150	°C	
Thermal Resistance from Junction-to-Ambient ³		R _{0JA}	59	°C/W	
Thermal Resistance from Junction-to-Case		R _{eJC}	0.33	°C/W	



Electrical Characteristics (T_J = 25°C, unless otherwise noted)

Parameter		Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static Characteristics					l	I	
Drain-Source Breakdown Voltage		V _{(BR)DSS}	V _{GS} = 0V, I _D = 250μA	100	-	-	V
Gate-body Leakage current		Igss	V _{DS} = 0V, V _{GS} = ±20V	-	-	±100	nA
Zero Gate Voltage Drain Current	T _J =25°C	_	.,	-	-	1	μА
	T _J =100°C	- I _{DSS}	V _{DS} =100V, V _{GS} = 0V	-	-	100	
Gate-Threshold Voltage		V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250µA	2	3	4	V
Drain-Source on-Resistance ⁴		R _{DS(on)}	V _{GS} = 10V, I _D = 20A	-	3.4	4.2	mΩ
Forward Transconductance ⁴		g fs	V _{DS} =10V, I _D =20A	-	76	-	s
Dynamic Characteristics	j	1			l .		
Input Capacitance		Ciss		-	9030	-	
Output Capacitance		Coss	V _{DS} = 50V, V _{GS} =0V, f =1MHz	-	1505	-	pF
Reverse Transfer Capacitance		Crss		-	40	-	
Gate Resistance		R_g	f=1MHz	-	2.3	-	Ω
Switching Characteristics	5	1					
Total Gate Charge		Qg		-	150	-	nC
Gate-Source Charge		Q _{gs}	V _{GS} = 10V, V _{DS} = 50V, I _D =20A	-	32.5	-	
Gate-Drain Charge		\mathbf{Q}_{gd}		-	49	-	
Turn-on Delay Time	elay Time t _{d(on)}		-	27	-		
Rise Time		tr	V _{GS} =10V, V _{DD} =50V,	-	78.5	-	ns
Turn-off Delay Time		t _{d(off)}	$R_G = 3\Omega$, $I_D = 20A$	-	110	-	
Fall Time		t _f		-	86	-	
Body Diode Reverse Recovery Time		t _{rr}		-	88	-	ns
Body Diode Reverse Recovery Charge		Qrr	- I _F = 20A, dI/dt=100A/μs	-	220	-	nC
Drain-Source Body Diode	Characteris	stics	1		1	1	
Diode Forward Voltage ⁴		V _{SD}	I _D = 20A, V _{GS} = 0V	-	-	1.2	V
Continuous Source Current	T _C =25°C	Is	-	-	-	260	Α

Notes:

- 1. Repetitive rating, pulse width limited by junction temperature $T_{J(MAX)}$ =150°C.
- 2. The EAS data shows Max. rating . The test condition is V_{DD} =50V, V_{GS} =10V, L=0.4mH, I_{AS} =54A.
- 3. The data tested by surface mounted on a 1 inch2 FR-4 board with 2OZ copper, The value in any given application depends on the user's specific board design.
- 4. The data tested by pulsed , pulse width \leq 300us , duty cycle \leq 2%.
- 5. This value is guaranteed by design hence it is not included in the production test.



Typical Characteristics

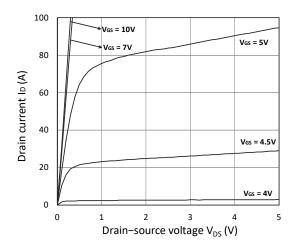


Figure 1. Output Characteristics

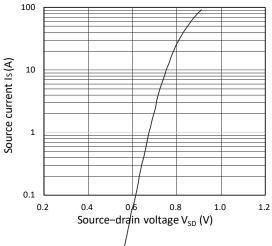


Figure 3. Forward Characteristics of Reverse

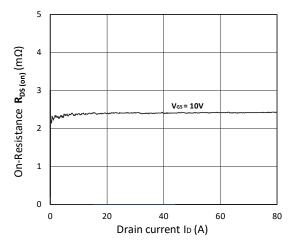


Figure 5. $R_{DS(ON)}$ vs. I_D

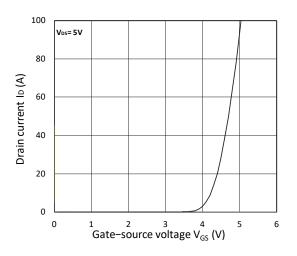


Figure 2. Transfer Characteristics

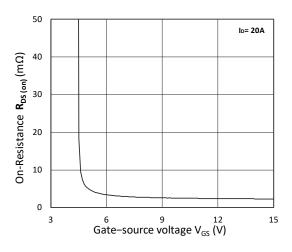


Figure 4. $R_{DS(ON)}$ vs. V_{GS}

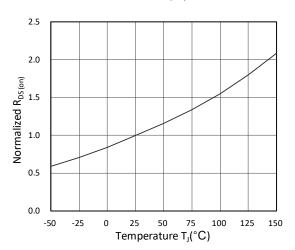


Figure 6. Normalized $R_{\text{DS}(\text{on})}$ vs. Temperature



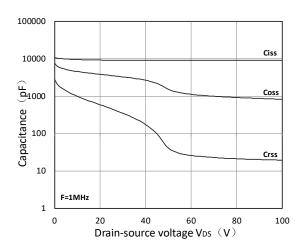


Figure 7. Capacitance Characteristics

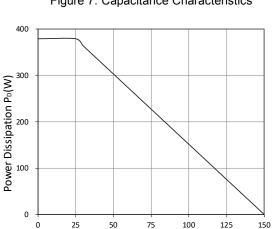


Figure 9. Power Dissipation

Case Temperature T_C (°C)

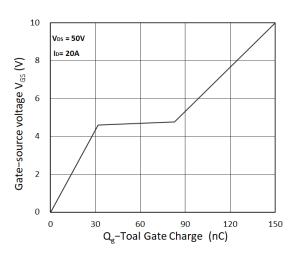


Figure 8. Gate Charge Characteristics

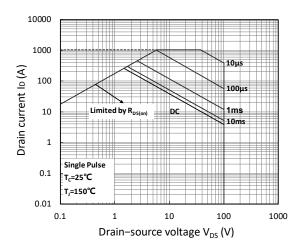


Figure 10. Safe Operating Area

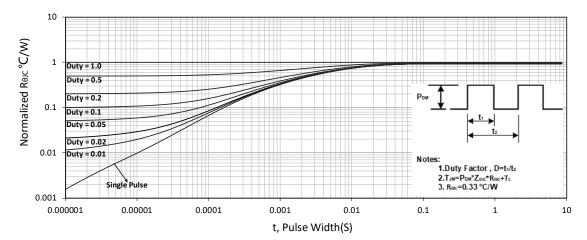
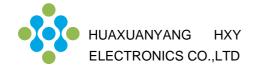


Figure 11. Normalized Maximum Transient Thermal Impedance



Test Circuit

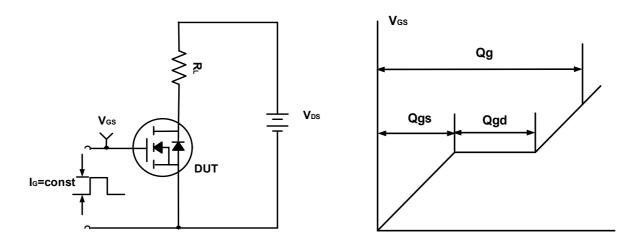


Figure A. Gate Charge Test Circuit & Waveforms

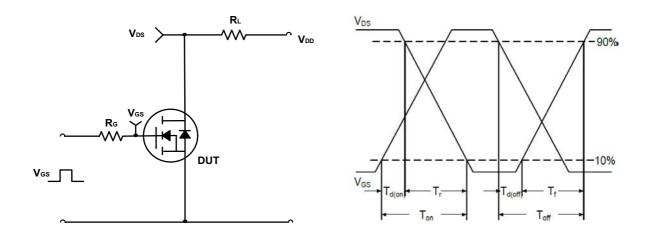


Figure B. Switching Test Circuit & Waveforms

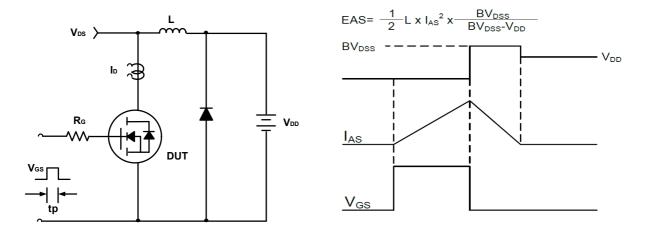
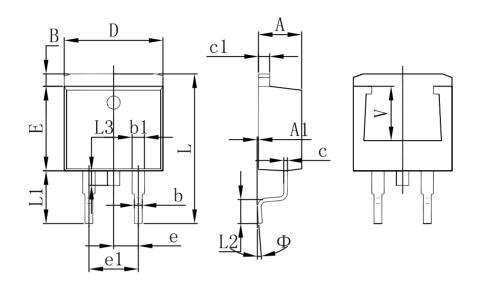


Figure C. Unclamped Inductive Switching Circuit & Waveforms



TO-263 Package Outline Dimensions



Symbol	Dimensions In Millimeters		Dimensions In Inches		
	Min.	Max.	Min.	Max.	
Α	4.470	4.670	0.176	0.184	
A1	0.000	0.150	0.000	0.006	
В	1.120	1.420	0.044	0.056	
b	0.710	0.910	0.028	0.036	
b1	1.170	1.370	0.046	0.054	
С	0.310	0.530	0.012	0.021	
c1	1.170	1.370	0.046	0.054	
D	10.010	10.310	0.394	0.406	
E	8.500	8.900	0.335	0.350	
е	2.540 TYP.		0.100 TYP.		
e1	4.980	5.180	0.196	0.204	
L	14.940	15.500	0.588	0.610	
L1	4.950	5.450	0.195	0.215	
L2	2.340	2.740	0.092	0.108	
L3	1.300	1.700	0.051	0.067	
Ф	0°	8°	0°	8°	
V	5.600 REF.		0.220REF.		



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